



PCB
LOGO
Texas Instruments

R44 was 127k
R47 was 41.2k

Functional Isolation Only

R35 was 68u

current sense

R43 was 100

added C100

3.3v at 30ma

44v or 8amp
bat +
rtn

R6, R7 was 100k

D9, D10 were MUR200

on heatsink

on heatsink

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